# Just the Beginning: The Post-Higgs Discovery LHC

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THE UNIVERSITY OF CHICAGO

# Outline

- Taking stock of the LHC's first run
- Runs II&III of the LHC: opportunities
- Higgs and the search for new physics
- Interlude concerning the ATLAS detector
- Runs II&III of the LHC: Challenges
- The Atlas FastTracKer (FTK) rises to the occasion
- Conclusions





























Squarks



Sleptons

SUSY force particles











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Squarks









Squarks

Quarks

Leptons

Force particles

SUSY force particles

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Sleptons

# The Large Hadron Collider So Far

• Triumphant discovery of a Higgs boson







#### The Large Hadron Collider So Far

• Triumphant discovery of a Higgs boson Quarks Forces Higgs Leptons





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• Not too heavy, not too light (experimentally, that is)





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Higher Energy Collisions:
8 TeV → 13-14 TeV





- Higher Energy Collisions:
  - 8 TeV → 13-14 TeV
- Many More Collisions:
  - Run II: 5x Run I dataset by 2017
  - Run III: 15x Run I dataset in 2021





process

• Significant increase in rate of many new physics scenarios





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 Is this really the Standard Model Higgs Boson?





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$$\begin{split} V &= m_{11}^2 \, \Phi_1^{\dagger} \Phi_1 + m_{22}^2 \, \Phi_2^{\dagger} \Phi_2 - m_{12}^2 \left( \Phi_1^{\dagger} \Phi_2 + \Phi_2^{\dagger} \Phi_1 \right) + \frac{\lambda_1}{2} \left( \Phi_1^{\dagger} \Phi_1 \right)^2 + \frac{\lambda_2}{2} \left( \Phi_2^{\dagger} \Phi_2 \right)^2 \\ &+ \lambda_3 \, \Phi_1^{\dagger} \Phi_1 \, \Phi_2^{\dagger} \Phi_2 + \lambda_4 \, \Phi_1^{\dagger} \Phi_2 \, \Phi_2^{\dagger} \Phi_1 + \frac{\lambda_5}{2} \left[ \left( \Phi_1^{\dagger} \Phi_2 \right)^2 + \left( \Phi_2^{\dagger} \Phi_1 \right)^2 \right], \end{split}$$



Ÿ,

 $H \rightarrow \tau \tau$ 

 $H \rightarrow \gamma \gamma$ 

 Is this really the Standard Model Higgs Boson?

- Is this the **only** Higgs Boson?
- $$\begin{split} V &= m_{11}^2 \, \Phi_1^{\dagger} \Phi_1 + m_{22}^2 \, \Phi_2^{\dagger} \Phi_2 m_{12}^2 \left( \Phi_1^{\dagger} \Phi_2 + \Phi_2^{\dagger} \Phi_1 \right) + \frac{\lambda_1}{2} \left( \Phi_1^{\dagger} \Phi_1 \right)^2 + \frac{\lambda_2}{2} \left( \Phi_2^{\dagger} \Phi_2 \right)^2 \\ &+ \lambda_3 \, \Phi_1^{\dagger} \Phi_1 \, \Phi_2^{\dagger} \Phi_2 + \lambda_4 \, \Phi_1^{\dagger} \Phi_2 \, \Phi_2^{\dagger} \Phi_1 + \frac{\lambda_5}{2} \left[ \left( \Phi_1^{\dagger} \Phi_2 \right)^2 + \left( \Phi_2^{\dagger} \Phi_1 \right)^2 \right], \end{split}$$

 $H \rightarrow 4I$ 

1.2

 $H \rightarrow bb$ 

κ<sub>v</sub>

Ldt = 4.6-4.8 fb

Ldt = 20.3 fb<sup>-1</sup>

• Why is the Higgs mass much lower than the Planck scale?





# The 3rd generation as a window to new physics

 Fermions have largest rate of Higgs decays, new physics could modify these couplings

- If we assume generic new physics which couples to the Higgs, then get third generation particles from Higgs decays
  - Multiple Higgses[e.g., arXiv: 1106.0034]
  - Massive gravitons [arXiv: 1307.0407]
- If we assume SUSY, then third generation superpartners stabilize the Higgs mass
  - Weak limits so far!

Model	$\kappa_V$	$\kappa_b$	$\kappa_{\gamma}$
Singlet Mixing	$\sim 6\%$	$\sim 6\%$	$\sim 6\%$
2HDM	$\sim 1\%$	$\sim 10\%$	$\sim 1\%$
Decoupling MSSM	$\sim -0.0013\%$	$\sim 1.6\%$	$\sim4\%$
Composite	$\sim -3\%$	$\sim -(3-9)\%$	$\sim -9\%$
Top Partner	$\sim -2\%$	$\sim -2\%$	$\sim +1\%$

arXiv:1310.8361





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							A.D*	
	$\tilde{b}_1 \tilde{b}_1, \tilde{b}_1 \rightarrow b \tilde{\chi}_1^0$	0	2 b	Yes	20.1	$\tilde{b}_1$		100-620 GeV
s c	$\tilde{b}_1 \tilde{b}_1, \tilde{b}_1 \rightarrow t \tilde{\chi}_1^{\pm}$	$2 e, \mu$ (SS)	0-3 <i>b</i>	Yes	20.7	$\tilde{b}_1$		27 <mark>5-430 GeV</mark>
Y O	$\tilde{t}_1 \tilde{t}_1$ (light), $\tilde{t}_1 \rightarrow b \tilde{\chi}_1^{\pm}$	1-2 $e,\mu$	1-2 <i>b</i>	Yes	4.7	$\tilde{t}_1$	110 <mark>-167 GeV</mark>	
na	$\tilde{t}_1 \tilde{t}_1$ (light), $\tilde{t}_1 \rightarrow W b \tilde{\chi}_1^0$	$2 e, \mu$	0-2 jets	Yes	20.3	$\tilde{t}_1$	130-220 GeV	
sd	$\tilde{t}_1 \tilde{t}_1$ (medium), $\tilde{t}_1 \rightarrow t \tilde{\tilde{\chi}}_1^0$	$2~e,\mu$	2 jets	Yes	20.3	$\tilde{t}_1$		225-525 GeV
	$\tilde{t}_1 \tilde{t}_1$ (medium), $\tilde{t}_1 \rightarrow b \tilde{\chi}_1^{\pm}$	0	2 b	Yes	20.1	$\tilde{t}_1$		150-580 GeV
it k	$\tilde{t}_1 \tilde{t}_1$ (heavy), $\tilde{t}_1 \rightarrow t \tilde{\chi}_1^0$	1 e, µ	1 <i>b</i>	Yes	20.7	$\tilde{t}_1$		200-610 GeV
С С С С	$\tilde{t}_1 \tilde{t}_1$ (heavy), $\tilde{t}_1 \rightarrow t \tilde{\chi}_1^0$	0	2 b	Yes	20.5	$\tilde{t}_1$		320-660 GeV
di	$\tilde{t}_1 \tilde{t}_1, \tilde{t}_1 \rightarrow c \tilde{\chi}_1^0$	0 m	ono-jet/c-ta	ag Yes	20.3	$\tilde{t}_1$	90-200 GeV	
	$\tilde{t}_1 \tilde{t}_1$ (natural GMSB)	2 e, $\mu$ (Z)	1 <i>b</i>	Yes	20.7	$\tilde{t}_1$		500 GeV
	$\tilde{t}_2\tilde{t}_2, \tilde{t}_2 \rightarrow \tilde{t}_1 + Z$	3 e,μ(Ζ)	1 <i>b</i>	Yes	20.7	$\tilde{t}_2$		271-520 GeV



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#### **3rd Generation Higgs Signatures**





# **3rd Generation New Physics Signatures**

• For example:



- And many more...
  - 4b: massive gravitons decay to Higgs, exotic Higgs decays to light scalars, etc.
  - 2 tau + MET: Heavy Higgs, direct stau production
  - 2 tau + 2 b: exotic Higgs decays, heavy Higgs decays







# **Particles in ATLAS**





### **Quarks and Gluons**







Jets

# Difficulties with b-quarks and taus

 Hard to distinguish from light quark and gluons in the detector

- But not hopeless:
  - Use decay characteristics to our advantage
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# **Runs II&III: Challenges**





- Run II (2015 to 2017): mean of 45 simultaneous interactions
- Run III (2018-2021): mean of up to 80 simultaneous interactions

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## Triggering: A major challenge

- At 40-80 interactions per crossing, triggering is very hard!
  - W→lv has 1kHz rate <sup>(a)</sup> 80 PU : Saturates output rate!!
- Particularly a problem for triggers with missing energy, multi-jets





#### **Recording The Data: Multi-Step Approach**



#### **Step 1: Quick and Dirty**



#### **Step 2: Selective Sight**



#### Step 3: The Full Picture (Almost)



#### The Atlas FastTracKer Steps Up



# Tracking at High Luminosity is Tricky



• Huge combinatorial problem, very non-linear with number of interactions

 Atlas FastTracKer (FTK) solves these problems with a hardware based approach



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#### FTK **Conceptual Design**

- **Parallelize** the problem: Divide the detector  $\eta$ - $\phi$  towers
- **Reduce** the data volume: Convert clusters into coarse resolution hits
- Eliminate costly loops: Compare hits to pre-stored patterns simultaneously
- **Simplify** algorithms: Use a linearized fit for track candidates
- Hardware solution: Implemented in **FPGAs or custom ASICs**

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Nuclear Instruments and Methods in Physics Research A278 (1989) 436-440 North-Holland, Amsterdam

#### VLSI STRUCTURES FOR TRACK FINDING

Mauro DELL'ORSO Dipartimento di Fisica, Università di Pisa, Piazza Torricelli 2, 56100 Pisa, Italy

Luciano RISTORI INFN Sezione di Pisa, Via Vecchia Livornese 582a, 56010 S. Piero a Grado (PI), Italy

Received 24 October 1988

We discuss the architecture of a device based on the concept of associative memory designed to solve the track finding problem. typical of high energy physics experiments, in a time span of a few microseconds even for very high multiplicity events. This "machine" is implemented as a large array of custom VLSI chips. All the chips are equal and each of them stores a number of "patterns". All the patterns in all the chips are compared in parallel to the data coming from the detector while the detector is being read out





#### **Stage 1: Data Formatting**





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#### • Route clusters to FTK eta-phi towers







• Hits are ganged together into coarse resolution hits





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 All possible patterns of coarse resolution hits determined from simulation





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# **Track Fitting**

 Problem: >90% of matched patterns (BINGOs) are from random association of hits Layer 4 Layer 3 Layer 2 Layer 1

• Solution: check if **full resolution** hits in matched patterns are compatible with a single charged particle





### **5 Picosecond Track Fitting**

#### • Linearized fits on FPGAs:

- Determine phasespace of possible tracks ( $\chi^2$ )
- Linear approximation calculated and defined by sector
- FPGAs multiply and add coordinates by constants to get  $\chi^2$
- Keep roads with at least 1 good track
- Fit 1 track / ns (1 track every 5 ps for full system)!



$$\chi_i = \sum_{j=1}^{N_c} S_{ij} x_j + h_i; i = 1, \dots, N_{\chi}$$



# The AUX Card

- Track fitting (and more!) carried out in Auxiliary Card
  - 128 in entire system!
- Converts hits to coarse resolution hits, sends to pattern matching
- Receives matched patterns and fetches full resolution hits
- Performs 8 layer fit to reject bad patterns
- Sends hits to 12 layer fit





#### **Efficiencies & Fake Rates**

- 93-94% efficiency with respect to offline tracks
- 3% fake rate at central eta, up to 10% at high eta





#### **Performance:Resolutions**

• Similar resolution to offline tracks at low p<sub>T</sub>, ~2x worse at highest p<sub>T</sub>

• Improved with some clustering changes (not shown here)





# **Performance: B-tagging**

- Use simple 2D Impact parameter significance b-tagger
- For 80% offline point can get 70% or higher relative FTK efficiency
  - Many improvements already implemented, not shown here







# **Performance:** Taus





- Tau algorithms run calo selection first, then tracking b/c of tracking time costs
- Integrate tracking from start
  - Then run more sophisticated calorimeter algorithms (not shown here)
  - Need to re-optimize offline in this case!



#### What FTK Buys Us

#### • More events with lower energy b-jets:

- Unless boosted, Higgs events have moderate  $p_T$  b-jets: ~50 GeV
- W/o FTK jet algorithms will apply jet energy threshold before b-tagging—loose efficiency!
- W/FTK can afford to tag all events which get past first level trigger
- Improvements for all b-jet physics cases, particularly for VBF Higgs, multi-b jet triggers
- More taus from Higgs:
  - More efficient selections (at least 30% increase over 2012 selections in VBF Higgs events from preliminary studies)
  - Lower thresholds:optimization in progress, expect reduction of ~15 GeV.





# **Other FTK Applications**



#### **Other FTK Applications**





#### **Other FTK Applications**



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# Conclusions

- LHC Run I was a fabulous success but left many questions to be answered
- The Higgs observation opens up new window into physics beyond the standard model
  - Non standard couplings, Multiple Higgses, New resonances decaying to Higgs
  - Third generation particles will be key to exploring the new landscape & answering those questions
- The rest of the LHC lifetime will be a challenging environment
  - Up to an average of 80 simultaneous interactions
- FTK will allow ATLAS to cope with the challenges of RunII&III and will be critical for final states with bs and taus







# Back-up


#### **FTK Status and Plans**





• It's a **scalar** particle



#### • It's a **scalar** particle









### LHC Plan\*

- Experiments request: 25 ns running with no significant 50ns dataset
- Machine reality: 50ns is easier/safer and will be used for 13 TeV commissioning before moving to 25 ns.
- Plan:
  - Low intensity for first 2 months, low number of bunches
  - Intensity ramp up with 50 ns (1-2months)
  - 50ns nominal running at <mu> of 40 to characterize machine
  - 25ns commissioning
- May have to run at lumi-leveled 50ns operation if 25ns has problems
- Stable operations possibilities:

Scheme	$N_b$	ppb $(10^{11})$	$\beta^*$ [cm]	emittance $[\mu m]$	peak	pile-up	$\mathcal{L} [\mathrm{fb}^{-1}]$
$25 \mathrm{ns}$	2760	1.15	55/43/189	3.75	9.3e33	25	24
25  ns BCMS	2760	1.15	45/43/189	1.9	1.7e34	52	$45_{+}$
$50  \mathrm{ns}$	1380	1.65	42/43/189	2.3	1.6e34	87	
50  ns BCMS	1380	1.6	38/43/189	1.6	2.3e34	138	$40^{\dagger}$



<u>\*Evian Summary</u> †Lumi-leveled

### **Run II and III conditions**





















12kHz





1kHz - 500Hz







1kHz - 500Hz



#### FTK in the ATLAS Trigger System





#### FTK in the ATLAS Trigger System





#### **Trigger rate evolution**





































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### **Stage 1: Clustering**



- Receive data from silicon detectors
- Cluster pixel hits using sliding window algorithm in FPGA



### The Clustering Implementation

- The current implementation is an evolution of a linear algorithm with a high cost in terms of FPGA resources
- In the previous algorithm grids of 168x4 or 328x8 pixels were used. For these grid sizes the extrapolated area and clock results (for the Spartan 6-LX150T) would be:

Grid Size	Slice Registers	Slice LUTs	Clock	Frequency
21x8 (current)	696 (1%)	1950 (2%)	12ns	83Mhz
168x4	2784 (1.5%)	7800 (8.2%)	68ns	14.8Mhz
328x8	10510 (5.7%)	30457 (33%)	265ns	3.8Mhz

### **Stage 1: Data Formatting**



- Implemented in ATCA crates with full mesh backplane
- 32 DF boards in 4 crates
- Each DF connects to 2 towers





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#### **Data Formatter Prototype**



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### AM technological evolution



- (90's) Full custom VLSI chip 0.7μm (INFN-Pisa)
  - 128 patterns, 6x12bit words each, 30MHz
- F. Morsani et al., IEEE Trans. on Nucl. Sci., vol. 39 (1992)



Alternative **FPGA** implementation of SVT AM chip P. Giannetti et al., Nucl. Intsr. and Meth., vol. A413/2-3, (1998)

G Magazzù, 1<sup>st</sup> std cell project presented @ LHCC (1999)



#### **Standard Cell 0.18** $\mu m \rightarrow 5000$ pattern/AM chip

SVT upgrade total: 6M pattern, 40MHz A. Annovi et al., IEEE TNS, Vol 53, Issue 4, Part 2, 2006



AMchip04 –65nm technology, std cell & full custom, 100MHz Power/pattern/MHz ~30 times less. Pattern density x12. First variable resolution implementation!

F. Alberti et al 2013 JINST 8 C01040, doi:10.1088/1748-0221/8/01/C01040


#### Pattern Recognition Associative Memory







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• Allows hits arriving at different times (but same event) to be compared!





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#### Refinements



- Majority Logic: Only require N out of M layers have a match
  - Gains efficiency
- Variable Resolution Patterns (Don't Care Bits)
  - Reduces the number of patterns and fake matches



• Number of don't care bits set on a layer by layer, pattern by pattern basis

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## **AMChips**









- AMBFTK is EURCARD 9U format
- Massive serial I/O
  - 2 Artix 7 FPGAs
  - Only serial communication busses
- Additional FPGAs for VME control
  - Slave for VME communication in the AUX-card
- LAMB redesigned for the newer AMchip
  - Serial communication replaced the parallel busses
  - See M. Beretta talk on 24/09
    - <u>https://indico.cern.ch/</u> <u>contributionDisplay.py?</u> <u>contribld=50&confld=228972</u>
- Different voltages to be distributed
  - 3.3V for the I/O
  - 1.2V AM-chip
- High power consumption, about 200 W

## AM working principle



# AM working principle



Pattern matching is completed as soon as all hits are loaded. Data arriving at different times is compared in parallel with all patterns. Unique to AM chip: look for correlation of data received at different times.



#### **Processing Unit**



- AMChips found in Processing Unit:
  - AMboard + AUX Card
- Each AMBoard is composed of 4 LAMBs with AM chips
  - Each LAMB-FTK will contain 16 AMChips, ~10<sup>6</sup> patterns/LAMB
- AM Board + AUX communicate through P3 Connector
  - Successfully tested 2GBps transfer

#### AUX



- 9U VME Rear Transition Card
  - 280mm deep!
- I/Os:
  - Fibers: to DF, SSB
  - P3 Connector: Data to AMB
    - 12 x Out @ 2Gbps
    - 16 x In @ 2Gbps
  - P2 Connector: VME control, power
- Processing power: 6 Arria V FPGAs
  - 20 Mb RAM, ~1000 DSPs each



#### FTK to Level 2

- FTK to Level 2 Interface Crate connects FTK to HLT
  - Formats data for HLT
  - Also does monitoring and control
- Uses dual-star ATCA crate
  - Will allow for local trigger processing (primary vertex finding, beamspot, MET, etc.) in the future





#### **Timing Simulation**

- Detailed timing studies based on per-word processing times for entire system
- 100 microsecond latency achievable at 70 interactions per crossing!





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#### **Summary of Prototype tests**

- AMChips: Custom cells tested and works well!
- Processing Unit:
  - High speed communication between AUX and AMB successful
  - On board HS communication for AUX successful
  - Cooling tests for AMB underway to determine crate configuration
- Clustering Mezzanine:
  - Data transfer (SCT) tested in with collision data
  - Connection to DF through SMD connector tested
- Data Formatter:
  - Onboard and backplane data transfer tested to 10Gbps







## Stage 3: 12-layer Track Fitting

 Use constants precomputed from linearized constraints to guess hit coordinates

$$x'_{i} = \sum_{j=1}^{11} H_{ij} x_{j} + g_{i}; i = 1, \dots, N_{\chi}$$

- Find matching hits
- Refit to find best  $\chi^2$  and track parameters
- Good tracks, with parameters, hits and errors are sent to final crate for formatting for the ATLAS trigger system



